



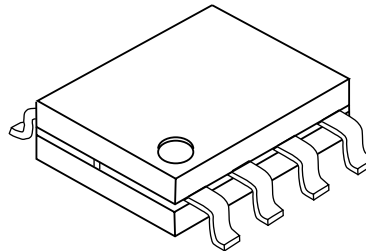
DC – 16 GHz Packaged Divide-by-4 Prescaler

Technical Data

HMMC-3104

Features

- **Wide Frequency Range:**
0.2 - 16 GHz
- **High Input Power Sensitivity:**
On-chip pre- and post-amps
-20 to +10 dBm (1 - 10 GHz)
-15 to +10 dBm (10 - 12 GHz)
-10 to +5 dBm (12 - 15 GHz)
- **P_{out}:** +6 dBm (0.99 V_{p-p}) will drive ECL
- **Low Phase Noise:**
-153 dBc/Hz @ 100 kHz Offset
- **(+) or (-) Single Supply Bias with Wide Range:**
4.5 to 6.5 V
- **Differential I/O with on-chip 50 Ω matching**



Package Type: 8-lead SSOP Plastic
Package Dimensions: 4.9 x 3.9 mm Typ.
Package Thickness: 1.55 mm Typ.
Lead Pitch: 1.25 mm Nom.
Lead Width: 0.42 mm Nom.

Description

The HMMC-3104 is a packaged GaAs HBT MMIC prescaler which offers DC to 16 GHz frequency translation for use in communications and EW systems incorporating high-frequency PLL oscillator circuits and signal-path down conversion applications. The prescaler provides a large input power sensitivity window and low phase noise.

Absolute Maximum Ratings^[1]

(@ T_A = 25°C, unless otherwise indicated)

| Symbol | Parameters/Conditions | Units | Min. | Max. |
|-----------------------------------|--|-------|----------------------|-----------------------|
| V _{CC} | Bias Supply Voltage | volts | | +7 |
| V _{EE} | Bias Supply Voltage | volts | -7 | |
| V _{CC} - V _{EE} | Bias Supply Delta | volts | +7 | |
| V _{Logic} | Logic Threshold Voltage | volts | V _{CC} -1.5 | V _{CC} -1.2 |
| P _{in(CW)} | CW RF Input Power | dBm | | +10 |
| V _{RFIn} | DC Input Voltage (@ RF _{in} or $\overline{\text{RF}}_{\text{in}}$ Ports) | volts | | V _{CC} ± 0.5 |
| T _{BS} ^[2] | Backside Operating Temp. | °C | -40 | +85 |
| T _{STG} | Storage Temperature | °C | -65 | +165 |
| T _{max} | Maximum Assembly Temp. (60 seconds max.) | °C | | 310 |

Notes:

1. Operation in excess of any parameter limit (except T_{BS}) may cause permanent damage to the device.
2. MTTF > 5 x 10⁵ hours @ T_{BS} < 85°C. Operation in excess of maximum operating temperature (T_{BS}) will degrade MTTF.

HMMC-3104 DC Specifications/Physical Properties,

($T_A = 25^\circ\text{C}$, $V_{CC} - V_{EE} = 5.0\text{ V}$ unless otherwise listed)

| Symbol | Parameters and Test Conditions | Units | Min. | Typ. | Max. |
|---------------------------------|--|-------|-----------------|-----------------|-----------------|
| $V_{CC} - V_{EE}$ | Operating Bias Supply Difference ^[1] | volts | 4.5 | 5.0 | 6.5 |
| $ I_{CC} $ or $ I_{EE} $ | Bias Supply Current | mA | 68 | 80 | 92 |
| $V_{RFin(q)}$ $V_{RFout(q)}$ | Quiescent DC Voltage appearing at all RF Ports | volts | | V_{CC} | |
| V_{Logic} | Nominal ECL Logic Level (V_{Logic} contact self-bias voltage, generated on-chip) | volts | $V_{CC} - 1.45$ | $V_{CC} - 1.35$ | $V_{CC} - 1.25$ |

Note:

1. Prescaler will operate over full specified supply voltage range. V_{CC} or V_{EE} not to exceed limits specified in Absolute Maximum Ratings section.

RF Specifications, ($T_A = 25^\circ\text{C}$, $Z_O = 50\Omega$, $V_{CC} - V_{EE} = 5.0\text{ V}$)

| Symbol | Parameters and Test Conditions | Units | Min. | Typ. | Max. |
|------------------------|---|--------|------|------|------|
| $f_{in(max)}$ | Maximum input frequency of operation | GHz | 16 | 18 | |
| $f_{in(min)}$ | Minimum input frequency of operation ^[1] ($P_{in} = -10\text{ dBm}$) | GHz | | 0.2 | 0.5 |
| $f_{Self-Osc.}$ | Output Self-Oscillation Frequency ^[2] | GHz | | 3.4 | |
| P_{in} | @ DC, (Square-wave input) | dBm | -15 | >-25 | +10 |
| | @ $f_{in} = 500\text{ MHz}$, (Sine-wave input) | dBm | -15 | >-20 | +10 |
| | $f_{in} = 1\text{ to }10\text{ GHz}$ | dBm | -15 | >-25 | +10 |
| | $f_{in} = 10\text{ to }12\text{ GHz}$ | dBm | -10 | >-15 | +10 |
| | $f_{in} = 12\text{ to }15\text{ GHz}$ | dBm | -4 | >-10 | +4 |
| RL | Small-Signal Input/Output Return Loss (@ $f_{in} < 12\text{ GHz}$) | dB | | 15 | |
| S_{12} | Small-Signal Reverse Isolation (@ $f_{in} < 12\text{ GHz}$) | dB | | 30 | |
| ϕ_N | SSB Phase Noise (@ $P_{in} = 0\text{ dBm}$, 100 kHz offset from a $f_{out} = 1.2\text{ GHz}$ Carrier) | dBc/Hz | | -153 | |
| Jitter | Input Signal Time Variation @ Zero-Crossing ($f_{in} = 10\text{ GHz}$, $P_{in} = -10\text{ dBm}$) | ps | | 1 | |
| T_r or T_f | Output Transition Time (10% to 90% rise/fall time) | ps | | 70 | |
| $P_{out}^{[3]}$ | @ $f_{out} < 1\text{ GHz}$ | dBm | 4 | 6 | |
| | $f_{out} = 2.5\text{ GHz}$ | dBm | 3.5 | 5.5 | |
| | $f_{out} = 3.5\text{ GHz}$ | dBm | 0 | 2.0 | |
| $ V_{out(p-p)} ^{[4]}$ | @ $f_{out} < 1\text{ GHz}$ | volts | | 0.99 | |
| | $f_{out} = 2.5\text{ GHz}$ | volts | | 0.94 | |
| | $f_{out} = 3.5\text{ GHz}$ | volts | | 0.63 | |
| $P_{Spitback}$ | f_{out} power level appearing at RF_{in} or \overline{RF}_{in} (@ $f_{in} = 12\text{ GHz}$, Unused RF_{out} or \overline{RF}_{out} unterminated) | dBm | | -40 | |
| | f_{out} power level appearing at RF_{in} or \overline{RF}_{in} (@ $f_{in} = 12\text{ GHz}$, Both RF_{out} & \overline{RF}_{out} terminated) | dBm | | -47 | |
| $P_{feedthru}$ | Power level of f_{in} appearing at RF_{out} or \overline{RF}_{out} (@ $f_{in} = 12\text{ GHz}$, $P_{in} = 0\text{ dBm}$, Referred to $P_{in}(f_{in})$) | dBc | | -23 | |
| H_2 | Second harmonic distortion output level (@ $f_{out} = 3.0\text{ GHz}$, Referred to $P_{out}(f_{out})$) | dBc | | -25 | |

Notes:

1. For sine-wave input signal. Prescaler will operate down to D.C. for square-wave input signal. Minimum divide frequency limited by input slew-rate.
2. Prescaler can exhibit this output signal under bias in the absence of an RF input signal. This condition may be eliminated by use of the input DC offset technique described on page 3.
3. Fundamental of output square wave's Fourier Series.
4. Square wave amplitude calculated from P_{out} .

Applications

The HMMC-3104 is designed for use in high frequency communications, microwave instrumentation, and EW radar systems where low phase-noise PLL control circuitry or broad-band frequency translation is required.

Operation

The device is designed to operate when driven with either a single-ended or differential sinusoidal input signal over a 200 MHz to 16 GHz bandwidth. Below 200 MHz the prescaler input is "slew-rate" limited, requiring fast rising and falling edge speeds to

properly divide. The device will operate at frequencies down to DC when driven with a square-wave. AC coupling at $P_{in} 5$ (RF_{in}) is recommended for most applications.

The device can be operated from either a single positive or single negative supply. For positive supply operation V_{CC} pins are nominally biased at any voltage in the +4.5 to +6.5 volt range with $P_{in} 8$ (V_{EE}) grounded. For negative bias operation V_{CC} pins are typically grounded and a negative voltage between -4.5 to -6.5 volts is applied to $P_{in} 8$ (V_{EE}).

Input DC Offset

To prevent false triggers or self-oscillation conditions, apply a 20 to 100 mV DC offset voltage between the RF_{in} and \overline{RF}_{in} ports. This prevents noise or spurious low level signals from triggering the divider.

GaAs MMICs are ESD sensitive. Proper precautions should be used when handling these devices.

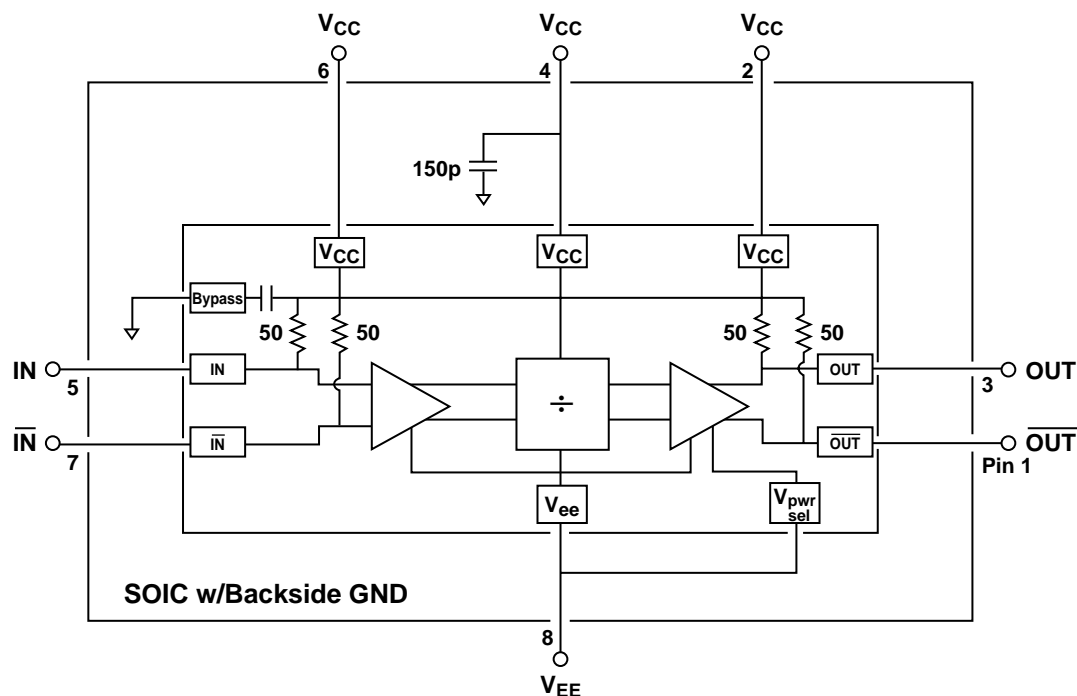


Figure 1. HMMC-3104 Simplified Schematic.

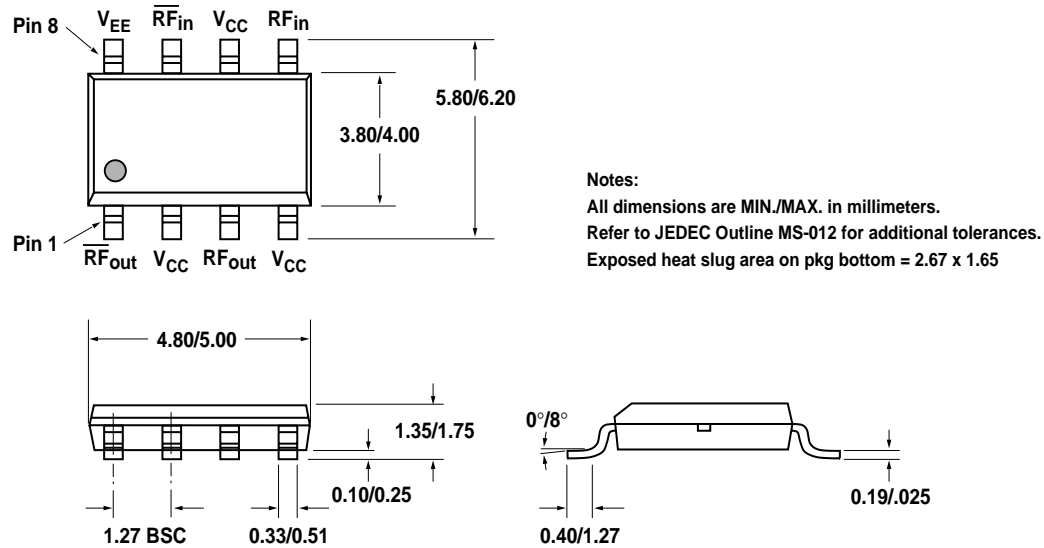


Figure 2. Package and Dimensions.

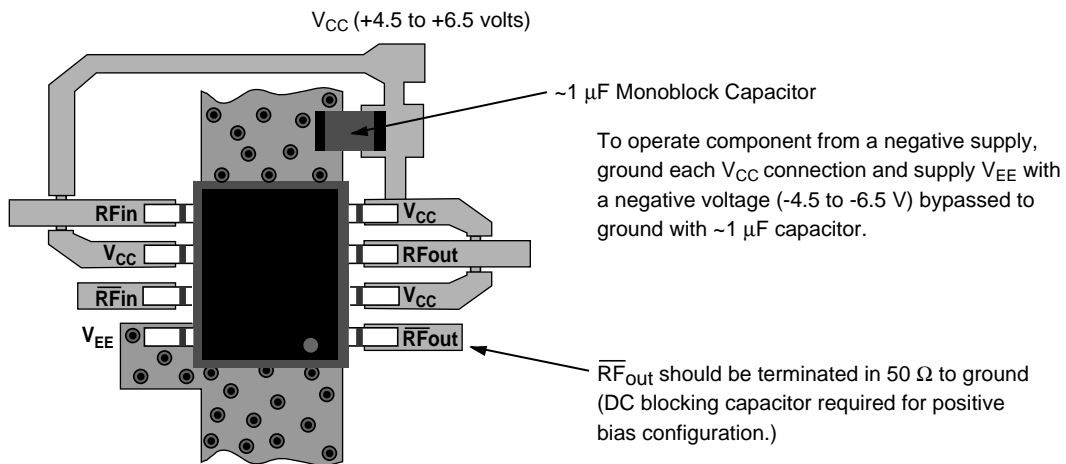


Figure 3. Assembly Diagram. (single-supply, positive-bias configuration shown)

HMMC-3104 Supplemental Data

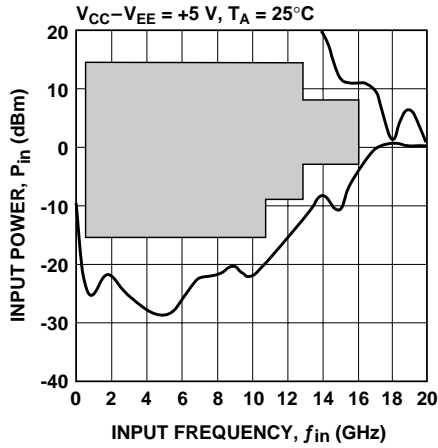


Figure 4. Typical Input Sensitivity Window.

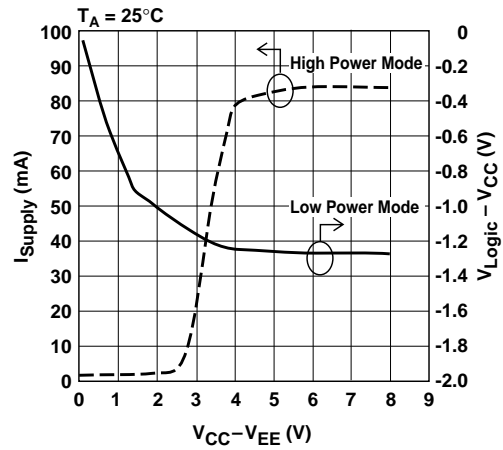


Figure 5. Typical Supply Current & V_{Logic} vs. Supply Voltage.

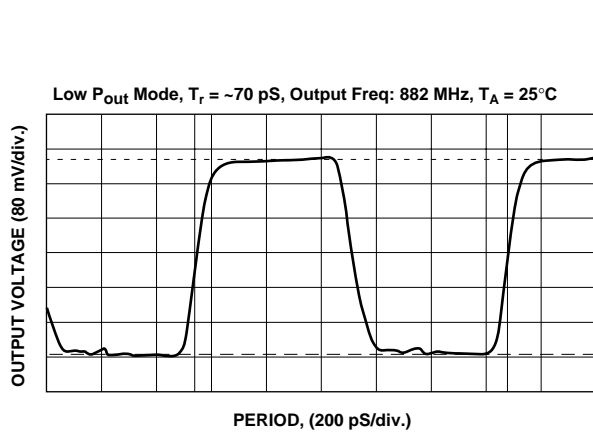


Figure 6. Typical Output Voltage Waveform.

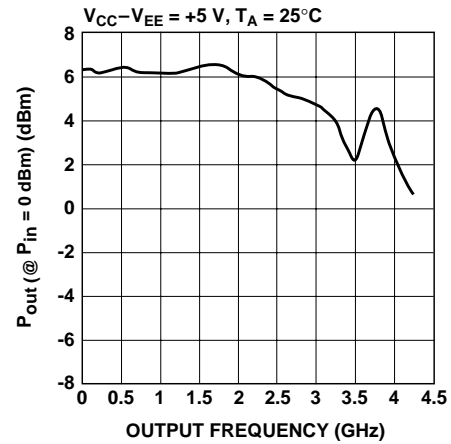


Figure 7. Typical Output Power vs. Output Frequency, f_{out} (GHz).

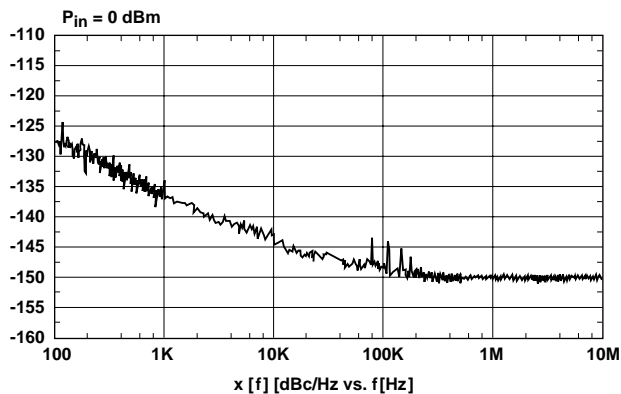


Figure 8. Typical Phase Noise Performance.

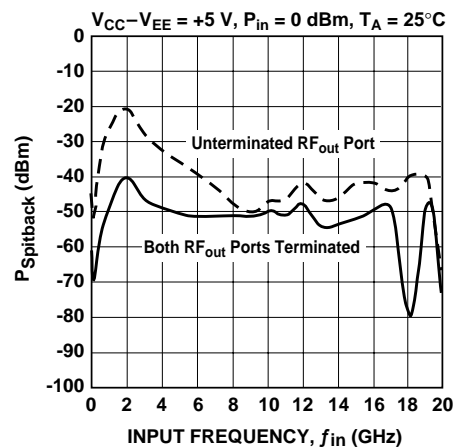


Figure 9. Typical "Spitback" Power. $P(f_{out})$ appearing at RF input port.



Supplemental Information

Input DC Offset

As long as an RF signal is always present and within the input power specifications, there will not be any problems with false triggering or self-oscillations. If this is not the case, you can put $\approx 10\text{K}\Omega$ to ground from the unused input and this, when combined with the on-chip 50Ω resistor to $V_{CC} = 5$, will put an offset of $\approx 25\text{ mV}$ between the RF inputs (i.e., if $\overline{\text{RF}}_{\text{in}}$ has $10\text{K}\Omega$ to ground, it will be at $\approx 4.975\text{ V}$ and RF_{in} will be at $\approx 5\text{ V}$). If you want a 20 to 100 mV offset per the note on page 3, the resistor value to ground will be $12.45\text{K}\Omega$ to $2.45\text{K}\Omega$ when $V_{CC} = 5$.

Biasing and DC-Blocking

The backside of the divider chip is gold plated and attached to the heat slug in the package. Also in the package is a capacitor connected between the chip's topside V_{CC} rail and the heat slug making the heat slug an RF ground. In the majority of cases, you would tie the exposed heat slug on the bottom of the package to ground. In a typical positive bias setup with $V_{CC} = 5$, V_{EE} is DC ground

along with the package's heat slug. The RF input and RF output nodes are each tied to V_{CC} through 50Ω and will be floating nominally at that bias level (depending, of course, on the input drive level and the appropriate output state) so blocking capacitors will usually be required. For a typical negative bias setup with $V_{EE} = -5$, V_{CC} is DC ground along with the package's heat slug. In some cases, such as level shifting to subsequent stages, you might want to "float" the package and apply bias as the difference between V_{CC} and V_{EE} . For such applications, the package's heat slug must be attached to a point that is both a good heat sink and a good RF ground.

Heat Slug/Bonding Pad

The exposed area of the package's backside heat slug (or pad) measures $2.67 \times 1.65\text{ mm}$ ($0.105" \times 0.065"$). Anything larger than this on a PCB would be at the customer's preference or convenience. On our test PCBs, we use a $0.200" \times 0.082"$ pad with eight $0.020"$ diameter solder-filler thermal vias.